ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES INDUSTRIES	C, Bannockb	ourn, Illinois. A	Il rights reserved untions.	under both	This docume level parts, t	ent is a declarati the declaration e	on of the subs ncompasses a	stances w all lower l	vithin the manufacture level materials for wh	er listed it hich the m	tem. Note: i nanufacturer	f the item is an as r has engineering	ssembly with lower responsibility.
				Form Type Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials				als and M	ls and Mfg Information			
Supplier Information													
Company name*	Company unique ID			Unique ID Authority				Response Date*					
onsemi										2024-05-12			
Contact Name Title - Contact			t			Phone - Contact*				Email - Contact*			
Product-Env-Stewards Product			Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com			
Authorized Representative* Title -			itle - Representative			Phone - Representative*			Email - Representative*				
Product-Env-Stewards Pr			Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com			
Requester Item Number	Requester Item Number Mfr Item		Number Mfr Item Name			Effective Date	Version	Ma	Manufacturing Site		Weight*	UOM	Unit Type
	FDG633	FDG6332C-F085 Dual NP M		P MOS SC70-6 20V		2024-05-12		PB	PBB		5.758	mg	Each
Manufacturing Proccess Informat	ion												·
Terminal Plating / Grid Array Material Terminal Base Alloy			Alloy	J-STD-020 MSL	Rating	Peak Proc	ess Body Ten	nperature	Max Time at Peak	Temperat	ure Numb	per of Reflow Cy	cles
Matte Tin (Sn) - annealed CU Alloy				1		260	0	2	30	secon	ds 3		
Comments													
evel 1 - maximum time at peak temperatur	e during sol	dering is 10-3	0 seconds										
or more information regarding material c	omposition	please refer to	o page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed				
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		nium (Cr6+), Polybro	ominated Biphenyls (PBB), Polybron	dmium and quantity limit of 0.1% by mass (100 minated Diphenyl Ethers (PBDE), and Bis(2-eth					
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of				
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted				
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.									
Exemption List Version	EL-2011/534/EU								
Declaration Signature									
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the				
Supplier Digital Signature Ra	stislav Drska	Le							

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

sigma range of distribution unless otherwise noted).									
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure	
Die	0.148	mg	Supplier	Silicon (Si)	7440-21-3		0.148	mg	
Lead Frame	2.086	mg	Supplier	Silver (Ag)	7440-22-4		0.0134	mg	
			Supplier	Tin (Sn)	7440-31-5		0.2422	mg	
			Supplier	Manganese (Mn)	7439-96-5		0.015	mg	
			Supplier	Silicon (Si)	7440-21-3		0.0052	mg	
			В	Nickel (Ni)	7440-02-0		0.7854	mg	
			Supplier	Iron (Fe)	7439-89-6		1.0249	mg	
Mold Compound-Black	3.224	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.645	mg	
			Supplier	Carbon Black (C)	1333-86-4		0.032	mg	
			Supplier	Fused Silica (SiO2)	60676-86-0		2.547	mg	
Plating	0.274	mg	Supplier	Tin (Sn)	7440-31-5		0.274	mg	
Wire Bond - Au	0.026	mg	Supplier	Gold (Au)	7440-57-5		0.026	mg	

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3